Attorney Docket No. 300.1119

UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Masatoshi AKAGAWA, et al.

Application No.: 10/612,222

Group Art Unit: 3726

Confirmation No. 5751

Filed: July 3, 2003

Examiner: Rick Kiltae Chang

For:

COMPONENT-EMBEDDED BOARD FABRICATION METHOD AND APPARATUS FOR HIGH-PRECISION AND EASY FABRICATION OF COMPONENT-EMBEDDED BOARD

WITH ELECTRONIC COMPONENTS EMBEDDED IN WIRING BOARD

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure provisions of 37 CFR § 1.56, there is hereby provided certain information which the Examiner may consider material to the examination of the subject U.S. patent application. It is requested that the Examiner make this information of record if it is deemed material to the examination of the subject application.

1.	Enclosures accompanying this Information Disclosure Statement are:			
		1a. 🔯	Form PTO-1449.	
		1b. 🔯	Copy(ies) of IDS citation(s), except for U.S. Patents and U.S. Patent Application publications.	
		1c. 🛚	English language copy of a communication(s) from a foreign Patent Office or a PCT International Search Report.	
		1d. 🛚	English language translation (complete, Abstract or relevant portion(s)) attached to non-English language publications as indicated on the attached Form PTO-1449.	
		1e. 🗌	Explanations of Relevancy of References (ATTACHMENT 1(e), hereto) for providing a concise explanation of non-English publications.	
		1f. 🗌	List of Copending Applications (ATTACHMENT 1(f), hereto).	10512222
		1g. 🔲	List of Additional Submitted Documents (A 1/1/A Chivin III) (9) Innereto):	IM91CCCC
2.		This Infor	mation Disclosure Statement is filed under 37^{1} CFR 5 1.97(b):	
			(Check either Item 2a or 2b or 2c or 2d)	
		2a. 🔲	Within three months of the filing date of a national application;	
		2b. 🗌	Within three months of the date of entry of the national stage as set forth in	
			§ 1.491 in an international application.	
		2c. 📙	Before the mailing of a first Office Action on the merits; or	

Serial No.: 10/612,222

		2d.	Before the mailing of a first Office Action after the filing of a Request for Continued Examination under § 1.114.		
3.		specified Action und	mation Disclosure Statement is filed under 37 CFR § 1.97(c) after the period in paragraph 2 above but before the mailing date of any of a Final Office der § 1.113, a Notice of Allowance under § 1.311 or an action that otherwise essecution in the application, AND (Check either Item 3a or 3b; Item 3b to be checked if any reference known for more than 3 months)		
		20 □	The § 1.97(e) Statement in Item 5 below is applicable; OR		
		3a.	The \$1.97(e) Statement in item 5 below is applicable, OK The \$180.00 fee set forth in 37 CFR § 1.17(p) is: enclosed.		
			to be charged to Deposit Account No. 19-3935.		
4.	\boxtimes	This Infor	mation Disclosure Statement is filed under 37 CFR § 1.97(d) after the period in paragraph 3 above, but on or before payment of the Issue Fee, AND		
		4a. ⊠ 4b. ⊠	The § 1.97(e) Statement in Item 5 below is applicable; AND The \$180.00 fee set forth in 37 CFR § 1.17(p) is: ———————————————————————————————————		
			to be charged to Deposit Account No. 19-3935.		
5.	\boxtimes	Statemen	t under § 1.97(e) (applicable if Item 3a or Item 4a is checked)		
	23	(Check either Item 5a or 5b)			
		5a. 🛚	In accordance with 37 CFR § 1.97(e)(1), it is stated that each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this		
•		5b. 🗌	Information Disclosure Statement. In accordance with 37 CFR § 1.97(e)(2), it is stated that no item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in this Information Disclosure Statement was known by any individual designated in § 1.56(c) more than three months prior to the filing of this Information Disclosure Statement.		
6.		This is a o	continuation/divisional/continuation-in-part application under 37 CFR §		
			(Check appropriate Items 6a and/or 6b)		
		6a. 🗌	Copies of the publications listed on the attached Form PTO-1449 which were previously cited in prior application Serial No, filed on, and which is relied on for an earlier effective filing date for the subject application under 35 U.S.C. § 120, have been omitted pursuant to 37 CFR § 1.98(d).		
		6b. 🗌	Copies of the publications listed on the attached Form PTO-1449 which were not previously cited in prior application Serial No. — filed on — and		

Serial No.: 10/612,222

which is relied on for an earlier effective filing date for the subject application under 35 U.S.C. § 120, are provided herewith.

7.		This is a Request for Continued Examination under 37 CFR § 1.114. (Check either Item 7a or 7b)				
		7a. [The Issue Fee has not been paid. A Petition to Withdraw from issue under 37 CFR § 1.313(c) is filed concurrently herewith or has been granted. A Request for Continued Examination under 37 CFR § 1.114, after payment of the Issue Fee, is proper in accordance with 37 CFR § 1.114(a), respectively.			
8.		This is	a Supplemental Information Disclosure Statement. (Check either Item 8a or 8b)			
		8a. <u> </u>				
		8b				
9.	⊠ li u	n accord ndersto	dance with 37 CFR § 1.98, a concise explanation of what is presently od to be the relevance of each non-English language publication is: (Check appropriate Items 9a, 9b, 9c and/or 9d)			
		9a. <u> </u>				
		9b.	set forth in the application.			
		9d. 🗵				
10.	be se	e, mater earch re	sion is made that the information cited in this Statement is, or is considered to ial to patentability nor a representation that a search has been made (other than port(s) from a counterpart foreign application or a PCT International Search submitted herewith). 37 CFR §§ 1.97(g) and (h).			

Serial No.: 10/612,222

11. The Commissioner is authorized to credit any overpayment or charge any additional fee required under 37 CFR § 1.17 for this Information Disclosure Statement to Deposit Account No. 19-3935.

Respectfully submitted,

STAAS & HALSEY LLP

Dated: 11-20-2007

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Michael A. Leonard II Registration No. 60,180

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Masatoshi AKAGAWA, et al.

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REQUEST FOR CORRECTION OF IDS

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

In the IDS filed August 27, 2003, Japanese Patent Application No. 2000-323645 was mistakenly listed on Form PTO-1449 as "2002-323645". The appropriate Japanese Patent Application and an English translation were submitted with the IDS. The Applicant respectfully requests correction of the patent number to 2000-323645.

If any fees are required in connection with the filing of this Communication, please charge the fees to our Deposit Account No. 19-3935.

Respectfully submitted,

STAAS & HALSEY LLP

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Data.

11-20-2007

Rv.

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ATTACHMENT 1(e)

EXPLANATIONS OF RELEVANCY OF REFERENCES

•	11 17 10 111111111111111111111111111111			
ATTORNEY DOCKET NO.	APPLICATION NO.			
300.1119	10/612,222			
FIRST NAMED INVENTOR				
Masatoshi AKAGAWA, et al.				
FILING DATE	GROUP ART UNIT			
July 3, 2003	3726			

An Office Action was mailed on August 21, 2007 in the corresponding Japanese Patent Application. An English translation of the Office Action is included herewith. The Office Action cited five references. JPA No. 2000-323645 was previously submitted with the IDS filed August 27, 2003 along with an English translation thereof. JPA No. 4-72656, JPA No. 2001-332863 and JPA No. 10-41634 correspond with U.S. Patent No. 5,386,623, U.S. Publication No. 2004/0168825 and U.S. Patent No. 6,171,946, respectively. An English abstract for JPA No. 11-163499 is submitted herewith.